



Absolute Maximum Rati	ng (Note 1)						
Input Supply Voltage		Vin		+12			V
Enable Input Voltage		Vce		0 ~	0 ~ Vin+0.3		V
Output Current		lo		200			mA
Power Dissipation (Note 3)		PD		380			mW
Thermal Resistance		Өја		220			°C/W
Operating Junction Temperature Range		Тј		-40 ~ +125			°C
Storage Temperature Range		T _{STG}		-65 ~ +150			°C
Lead Soldering Temperature (260 °C)			5			S	
Recommend Operating	Rating						
Input Supply Voltage		Vin		+16			V
Enable Input Voltage		١	√ce	Gnd-0.3 ~ Vin+0.3			V
Electrical Characteristic	S					·	
Ta = 25 °C, lo=1mA, Cout=2.2uF,	Vce≥2V, unles	s othe	rwise specifie	ed.			
Parameter	Со	Conditions		Min	Тур	Max	Unit
Output Voltage	Vin=Vo + 1V	Vin=Vo + 1V		0.98 Vo		1.02 Vo	V
Output Voltage Temperature					100		ppm/ °C
Coefficient (Note 4)							
Line Regulation	$Vo+1V \le Vin \le 10V$			10	20	mV	
Load Regulation (Note 5)	Vin=Vo+1V,	Vin=Vo+1V,			30	80	
	1mA≤I _L ≤150r	mA	TS9011S				mV
	Vin=Vo+1V,		TS9011K		40	90	
	1mA≤I _L ≤80m	ιA	TS9011D				
Dropout Voltage (Note 6)	lo=150mA		TS90115		400		
	Io=150mA		TS9011S		400		mv
	10=100mA		TS9011K		600		
Quieseent Current	10=100mA		159011D		800	1000	
Ground Rin Current (Note 7)	Vin≤0.4V (shu		(1)		80	125	uA
	V CC=2 V		10=0. mA		350	600	υA
			lo=100mA		600	1000	
			lo=150mA		1300	1900	
Output Current Limit	Vout=0V				300		mA
Power Supply Rejection Ratio	At f=100Hz,	At f=100Hz, Io=0.1mA,			70		dB
Thermal Regulation (Note 8)				0.05		%/W	
Output Noise	lo=50mA, Co	lo=50mA, Cout=2.2uF,			260		nV√Hz
	470pF from bypass to Ground						



Electrical Characteristics							
Enable Input							
Parameter	Conditions	Min	Тур	Мах	Unit		
Enable Input Logic-Low Voltage	Regulation shutdown			0.4	V		
Enable Input Logic-High Voltage	Regulation enable	2.0			V		
Enable Input Current	V _{IL} ≤0.4V		0.01	1	uA		
	V _{IL} ≥2.0V	2	5	20			

Note 1: Exceeding the absolute maximum rating may damage the device.

Note 2: The device is not guaranteed to function outside its operating rating.

- Note 3: The maximum allowable power dissipation at any Ta is Pd(max) = [Tj(max) Ta] * Oja. Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.
- Note 4: Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
- Note 5: Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 1mA to 150mA(Vout>2.5V) and 1mA to 80mA(Vout<2.5V). Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- Note 6: Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.
- Note 7: Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.
- Note 8: Thermal regulation is defined as the change in output voltage at a time "t" after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 150mA load pulse at Vin=12V for t=10mS.







SOT-25 Mechanical Drawing





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SOT-23 DIMENSION						
DIM	MILLIM	ETERS	INCHES			
	MIN	MAX	MIN	MAX		
А	2.70	3.00	0.106	0.118		
В	0.25	0.50	0.010	0.020		
С	1.90(typ)		0.075(typ)			
D	0.95(typ)		0.037(typ)			
Е	1.50	1.70	0.059	0.067		
F	1.05	1.35	0.041	0.053		
Н	2.60	3.00	0.102	0.118		
L	0.60(typ)		0.024(typ)			